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M&amp;G- 50019.87US01/P05055



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A. Patent Application No.(s)

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10000 941

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5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Mark R. Hennings  
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6. Total number of applications and patents involved: 1

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PATENT  
REEL: 012352 FRAME: 0591

M&G 50019.87US01/P05055

### ASSIGNMENT

WHEREAS, I, Andrew J. Morrish, residing at 12657 Sun Valley Court, Saratoga, California 95070, made certain new and useful inventions and improvements as described and claimed in the specification forming part of an application for Letters Patent of the United States executed herewith, which is entitled **IMPROVED BIAS CIRCUIT FOR CLASS AB HIGH FREQUENCY AMPLIFIERS**.

AND WHEREAS, National Semiconductor Corporation, a corporation organized and existing under and by virtue of the laws of the State of Delaware, and having an office and place of business at 2900 Semiconductor Drive, Santa Clara, California 95051-8090 (hereinafter "Assignee") is desirous of acquiring the entire right, title and interest in and to said inventions, improvements and application and in and to the Letters Patent to be obtained therefor;

NOW THEREFORE, to all whom it may concern, be it known that for and in consideration of the sum of One Dollar and other good and valuable considerations, the receipt and sufficiency whereof is hereby acknowledged, I have sold, assigned, and transferred, and by these presents do sell, assign and transfer unto said Assignee, its successors or assigns, the entire right, title and interest for all countries in and to all inventions and improvements disclosed in the aforesaid application, and in and to the application, all divisions, continuations, or renewals thereof, all Letters Patent which may be granted therefrom, and all reissues or extensions of such patents, and in and to any and all applications which have been or shall be filed in any foreign countries for Letters Patent on the inventions and improvements, including an assignment of all rights under the provisions of the International Convention, and all Letters Patent of foreign countries which may be granted therefrom; and I do hereby authorize and request the Commissioner of Patents and Trademarks to issue any and all United States Letters Patent for the aforesaid inventions and improvements to the Assignee as the assignee of the entire right, title and interest in and to the same, for the use of the Assignee, its successors and assigns.

AND, for the consideration aforesaid, I do hereby agree that I and my executors and legal representatives will make, execute and deliver any and all other instruments in writing including any and all further application papers, affidavits, assignments and other documents, and will communicate to said Assignee, its successors and representatives all facts known to me relating to said improvements and the history thereof and will testify in all legal proceedings and generally do all things which may be necessary or desirable more effectually to secure to and vest in said Assignee, its successors or assigns the entire

